

Feed-through header - MC 1,5/ 2-G-3,81 P26 THRR24 - 1103274

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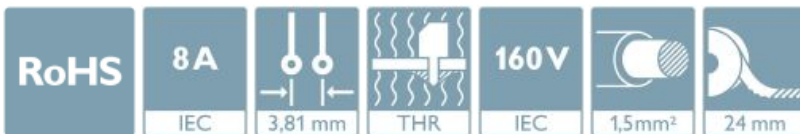
PCB headers, nominal cross section: 1.5 mm², color: black, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Tin, type of contact: Male connector, Number of rows: 1, Number of positions per row: 2, product range: MC 1,5/...-G-THR, pitch: 3.81 mm, mounting: THR soldering, pin layout: Linear pinning, solder pin [P]: 2.6 mm, Stecksystem: MINI COMBICON, Locking: without, type of packaging: 24 mm wide tape. User information and design recommendations for through hole reflow technology can be found under: Downloads



The figure shows a 10-position version of the product

Your advantages

- Designed for integration into the SMT soldering process
- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies



Key Commercial Data

Packing unit	400 pc
Minimum order quantity	400 pc
GTIN	
GTIN	4055626965833

Technical data

Item properties

Brief article description	Feed-through header
Plug-in system	MINI COMBICON
Type of contact	Male connector
Range of articles	MC 1,5/...-G-THR
Pitch	3.81 mm
Number of positions	2
Mounting type	THR soldering
Pin layout	Linear pinning
Number of levels	1

Electrical parameters

Nominal current	8 A
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Technical data

Electrical parameters

Nom. voltage	160 V
Rated voltage	160 V
Rated voltage (III/2)	160 V
Rated voltage (II/2)	250 V
Rated surge voltage (III/3)	2.5 kV
Rated surge voltage (III/2)	2.5 kV
Rated surge voltage (II/2)	2.5 kV

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/ JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 - 5 µm Sn)
Metal surface contact area (middle layer)	Nickel (1 - 3 µm Ni),
Metal surface soldering area (top layer)	Tin (3 - 5 µm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 - 3 µm Ni)

Material data - housing

Housing color	black (9005)
Insulating material	LCP
Insulating material group	IIIa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions for the product

Caption	Schematische Abbildung - weitere Details siehe Produktfamilienzeichnung im Download Center
Length [l]	9.2 mm
Width [w]	9.01 mm
Height [h]	9.5 mm
Pitch	3.81 mm
Height (without solder pin)	6.9 mm
Solder pin [P]	2.6 mm
Pin dimensions	0.8 x 0.8 mm

Dimensions for PCB design

Hole diameter	1.4 mm
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Packaging information

Type of packaging	24 mm wide tape
Pieces per package	400
Denomination packing units	Pcs.
[W] tape width	24 mm

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Technical data

Packaging information

[A] coil diameter	330 mm
[W2] coil overall dimension	30.4 mm
Outer packaging type	Transparent-Bag
ESD level	(D) electrostatically conductive
Specification	DIN EN 61340-5-1 (VDE 0300-5-1): 2008-07

General product information

Note	In accordance with IEC 61984, COMBICON connectors have no switching power (COC). During designated use, they must not be plugged in or disconnected when carrying voltage or under load.
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Processing notes

Process	Reflow/wave soldering
Specification	Following IPC/JEDEC J-STD-020D.1:2008-03
	Following IEC 61760-1:2006-04
	Following IEC 60068-2-58:2005-02
Moisture Sensitive Level	MSL 1
Classification temperature T _c	260 °C
Solder cycles in the reflow	3

Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

Air clearances and creepage distances

Clearances and creepage distances	IEC 60664-1:2007-04
Specification	IEC 60664-1:2007-04
Minimum clearance - inhomogeneous field (III/3)	1.5 mm
Minimum clearance - inhomogeneous field (III/2)	1.5 mm
Minimum clearance - inhomogeneous field (II/2)	1.5 mm
Minimum creepage distance value (III/3)	2.5 mm
Minimum creepage distance value (III/2)	1.6 mm
Minimum creepage distance value (II/2)	3.2 mm

Classifications

eCl@ss

eCl@ss 10.0.1	27440402
eCl@ss 11.0	27460201
eCl@ss 8.0	27440402
eCl@ss 9.0	27440402

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Classifications

ETIM

ETIM 5.0	EC002637
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